## WHAT IS CLAIMED IS:

A polymorph of Compound A of structural formula:

Compound A

selected from Forms II, III and IV having the physical characteristics described in the following Table:

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| Form                                       |                            | III                  | IV.   |
|--|----------------------------|----------------------|---|
| DSC extrapolated melting temperature onset | 134-136°C                  | 133°C                | 134° C  |
| XRPD (peak<br>positions, Cu K<br>alpha)    | 5.6<br>9.4<br>10.7<br>17.6 | 10.5<br>16.1<br>22.4 | 8.7<br>15.2<br>17.1<br>19.5<br>21.7<br>23.5<br>23.6 |

2. A polymorph in accordance with Claim 1 which is Form

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IV.

3. A sesquihydrate of Form I having a DSC of about 134-136°C, peak m.p. 138°C, an XRPD pattern of 7.1, 9.7, 11.8, 15.5, 20.1, 22.7 and 24.1, and further containing approximately 1.5 mol water per mol of compound A.

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- 4. A polymorph in accordance with Claim 1 which is Form IV.
- 5. A hemihydrate of Form IV in accordance with claim 45 containing 0.5 mol water per mol of compound A.
  - 6. A polymorph in accordance with claim 1 which is Form III.
- An amorphous form of Compound A in accordance with
  claim 1 obtained by cooling a molten sample of a crystalline form of Compound A.
- 8. A pharmaceutical composition comprised of a polymorph II, III or IV in accordance with claim 1 in combination with a pharmaceutically acceptable carrier.
  - 9. A Form II polymorph of Compound A of structural formula:

Compound A

having a DSC extrapolated melting temperature onset of ~131°C, and XRPD peak positions, Cu K alpha of 5.6, 9.4, 10.7 and 17.6.

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